CEL

GaAs INTEGRATED CIRCUIT

μPG2160T5K

L, S-BAND SINGLE CONTROL SPDT SWITCH

DESCRIPTION

The μPG2160T5K is a GaAs MMIC for L, S-band SPDT (Single Pole Double Throw) switch which was developed for mobile phone and other L, S-band applications.

This device can operate frequency from 0.5 to 3.0 GHz, with low insertion loss and high isolation.

This device is housed in a 6-pin plastic TSSON (Thin Shrink Small Out-line Non-leaded) package, and is suitable for high-density surface mounting.

FEATURES

- Supply voltage : V_{DD} = 2.4 to 2.8 V (2.6 V TYP.)
- Switch control voltage : $V_{cont\ (H)}$ = 2.4 to V_{DD} (2.6 V TYP.)
  : $V_{cont\ (L)}$ = −0.2 to 0.2 V (0 V TYP.)
- Low insertion loss : $L_{ins}1$ = 0.30 dB TYP. @ f = 0.5 to 1.0 GHz, V_{DD} = 2.6 V, $V_{cont\ (H)}$ = 2.6 V, $V_{cont\ (L)}$ = 0 V
  : $L_{ins}2$ = 0.35 dB TYP. @ f = 1.0 to 2.0 GHz, V_{DD} = 2.6 V, $V_{cont\ (H)}$ = 2.6 V, $V_{cont\ (L)}$ = 0 V
  : $L_{ins}3$ = 0.40 dB TYP. @ f = 2.0 to 2.5 GHz, V_{DD} = 2.6 V, $V_{cont\ (H)}$ = 2.6 V, $V_{cont\ (L)}$ = 0 V
  : $L_{ins}4$ = 0.50 dB TYP. @ f = 2.5 to 3.0 GHz, V_{DD} = 2.6 V, $V_{cont\ (H)}$ = 2.6 V, $V_{cont\ (L)}$ = 0 V
- High isolation : ISL1 = 25 dB TYP. @ f = 0.5 to 1.0 GHz, V_{DD} = 2.6 V, $V_{cont\ (H)}$ = 2.6 V, $V_{cont\ (L)}$ = 0 V
  : ISL2 = 18 dB TYP. @ f = 1.0 to 2.0 GHz, V_{DD} = 2.6 V, $V_{cont\ (H)}$ = 2.6 V, $V_{cont\ (L)}$ = 0 V
  : ISL3 = 17 dB TYP. @ f = 2.0 to 2.5 GHz, V_{DD} = 2.6 V, $V_{cont\ (H)}$ = 2.6 V, $V_{cont\ (L)}$ = 0 V
  : ISL4 = 13 dB TYP. @ f = 2.5 to 3.0 GHz, V_{DD} = 2.6 V, $V_{cont\ (H)}$ = 2.6 V, $V_{cont\ (L)}$ = 0 V
- Handling power : $P_{in\ (0.1\ dB)}$ = +21.0 dBm TYP. @ f = 2.0/2.5 GHz, V_{DD} = 2.6 V, $V_{cont\ (H)}$ = 2.6 V, $V_{cont\ (L)}$ = 0 V
- High-density surface mounting : 6-pin plastic TSSON package (1.0 × 1.0 × 0.37 mm)

APPLICATIONS

- L, S-band digital cellular or cordless telephone
- W-LAN, WLL and Bluetooth™ etc.

ORDERING INFORMATION

Part Number	Order Number	Package	Marking	Supplying Form
μPG2160T5K-E2	μPG2160T5K-E2-A	6-pin plastic TSSON (Pb-Free) Note	G4	• Embossed tape 8 mm wide • Pin 1, 6 face the perforation side of the tape • Qty 5 kpcs/reel

Note With regards to terminal solder (the solder contains lead) plated products (conventionally plated), contact your nearby sales office.

Remark To order evaluation samples, contact your nearby sales office.
Part number for sample order: μPG2160T5K-A

Caution Observe precautions when handling because these devices are sensitive to electrostatic discharge.

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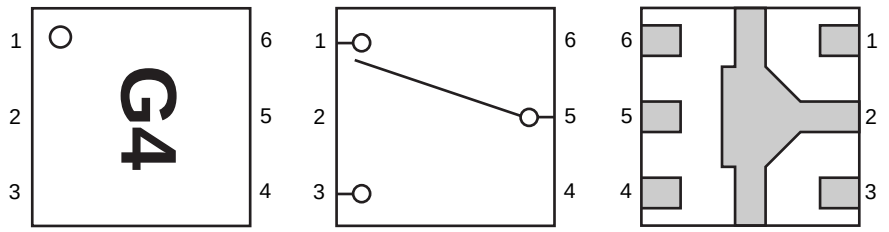
PIN CONNECTIONS AND INTERNAL BLOCK DIAGRAM

(Top View) (Top View) (Bottom View)



Pin No.	Pin Name
1	OUTPUT1
2	GND
3	OUTPUT2
4	V_{cont}
5	INPUT
6	V_{DD}

TRUTH TABLE

V_{cont}	INPUT–OUTPUT1	INPUT–OUTPUT2
High	OFF	ON
Low	ON	OFF

ABSOLUTE MAXIMUM RATINGS (T_A = +25°C, unless otherwise specified)

Parameter	Symbol	Ratings	Unit
Supply Voltage	V_{DD}	+6.0	V
Switch Control Voltage	V_{cont}	+6.0	V
Input Power	P_{in}	+26	dBm
Operating Ambient Temperature	T_A	–45 to +85	°C
Storage Temperature	T_{stg}	–55 to +135	°C

RECOMMENDED OPERATING RANGE (T_A = +25°C, unless otherwise specified)

Parameter	Symbol	MIN.	TYP.	MAX.	Unit
Supply Voltage [Note]	V_{DD}	2.4	2.6	2.8	V
Switch Control Voltage (H) [Note]	$V_{cont (H)}$	2.4	2.6	V_{DD}	V
Switch Control Voltage (L)	$V_{cont (L)}$	–0.2	0	0.2	V

Note $V_{cont (H)} \leq V_{DD}$

ELECTRICAL CHARACTERISTICS

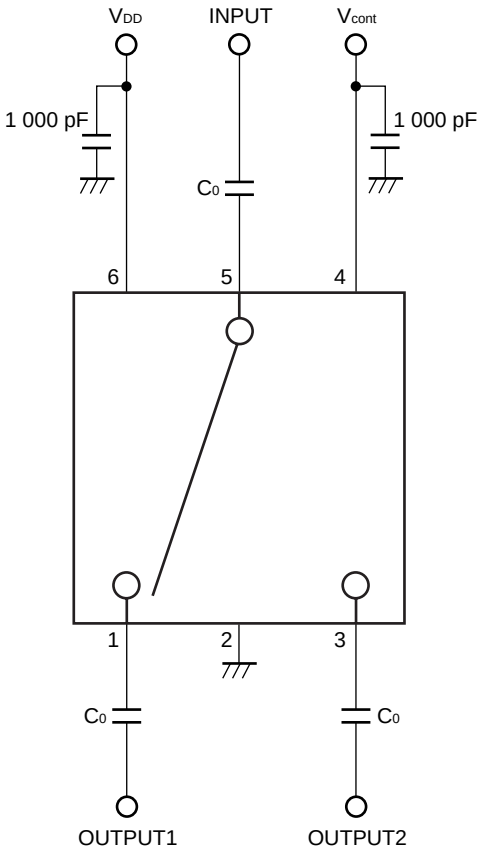
(T_A = +25°C, V_{DD} = 2.6 V, $V_{cont\ (H)}$ = 2.6 V, $V_{cont\ (L)}$ = 0 V, DC cut capacitors = 56 pF, unless otherwise specified)

Parameter	Symbol	Test Conditions	MIN.	TYP.	MAX.	Unit
Insertion Loss 1	$L_{ins}1$	f = 0.5 to 1.0 GHz	–	0.30	0.45	dB
Insertion Loss 2	$L_{ins}2$	f = 1.0 to 2.0 GHz	–	0.35	0.50	
Insertion Loss 3	$L_{ins}3$	f = 2.0 to 2.5 GHz	–	0.40	0.55	
Insertion Loss 4	$L_{ins}4$	f = 2.5 to 3.0 GHz	–	0.50	0.65	
Isolation 1	ISL1	f = 0.5 to 1.0 GHz	22	25	–	dB
Isolation 2	ISL2	f = 1.0 to 2.0 GHz	15	18	–	
Isolation 3	ISL3	f = 2.0 to 2.5 GHz	14	17	–	
Isolation 4	ISL4	f = 2.5 to 3.0 GHz	10	13	–	
Input Return Loss	RL_{in}	f = 0.5 to 3.0 GHz	15	20	–	dB
Output Return Loss	RL_{out}	f = 0.5 to 3.0 GHz	15	20	–	dB
0.1 dB Loss Compression Input Power [Note]	$P_{in\ (0.1\ dB)}$	f = 2.0/2.5 GHz	+18.0	+21.0	–	dBm
2nd Harmonics	$2f_0$	f = 2.0/2.5 GHz, P_{in} = +10 dBm	65	75	–	dBc
3rd Harmonics	$3f_0$	f = 2.0/2.5 GHz, P_{in} = +10 dBm	65	75	–	dBc
Supply Current	I_{DD}	No signal	–	50	100	μA
Switch Control Current	I_{cont}		–	4	20	μA
Switch Control Speed	t_{SW}	50% CTL to 90/10% RF	–	150	–	ns

Note $P_{in\ (0.1\ dB)}$ is measured the input power level when the insertion loss increases more 0.1 dB than that of linear range.

Caution This device is used it is necessary to use DC cut capacitors.

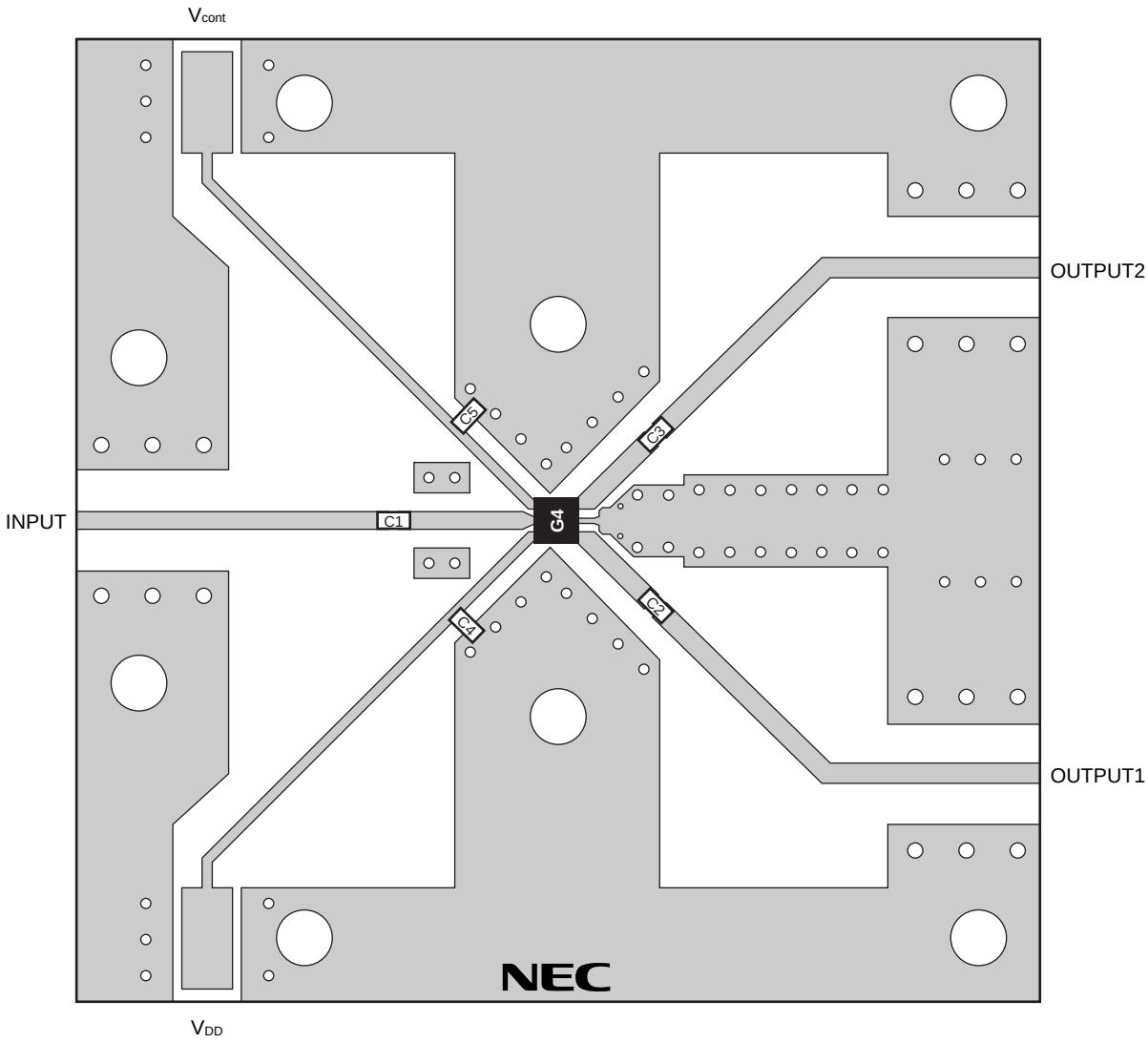
EVALUATION CIRCUIT



Remark C_0 : 56 pF

The application circuits and their parameters are for reference only and are not intended for use in actual design-ins.

ILLUSTRATION OF THE TEST CIRCUIT ASSEMBLED ON EVALUATION BOARD

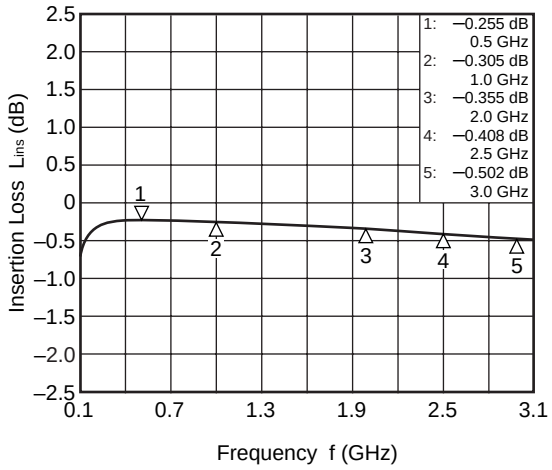


USING THE NEC EVALUATION BOARD

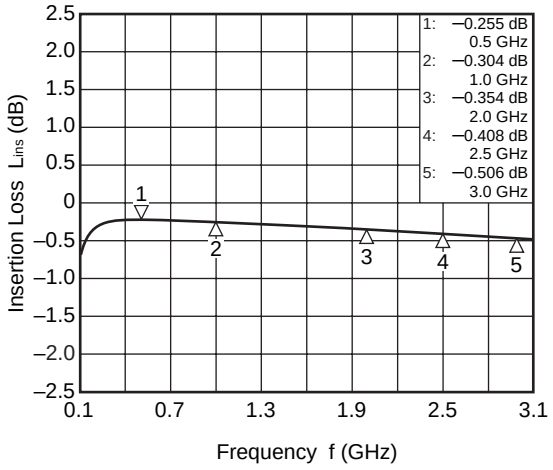
Symbol	Values
C1, C2, C3	56 pF
C4, C5	1 000 pF

TYPICAL CHARACTERISTICS (T_A = +25°C, V_{DD} = 2.6 V, $V_{cont\ (H)}$ = 2.6 V, $V_{cont\ (L)}$ = 0 V, DC cut capacitors = 56 pF, using test fixture, unless otherwise specified)

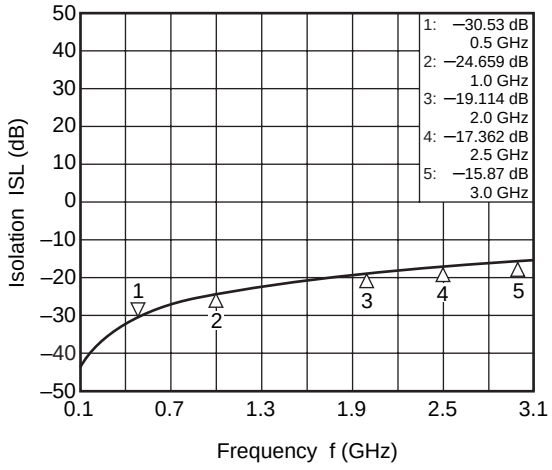
INPUT-OUTPUT1
INSERTION LOSS vs. FREQUENCY



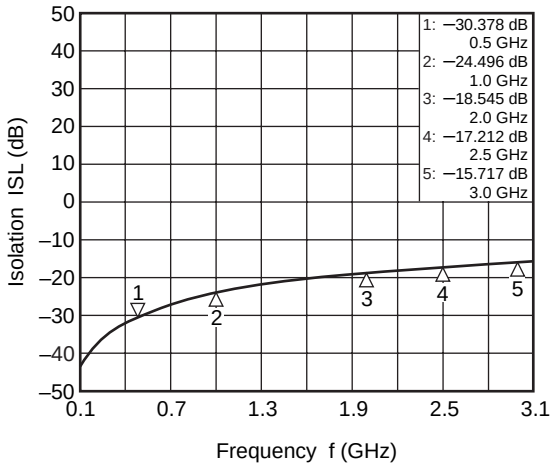
INPUT-OUTPUT2
INSERTION LOSS vs. FREQUENCY



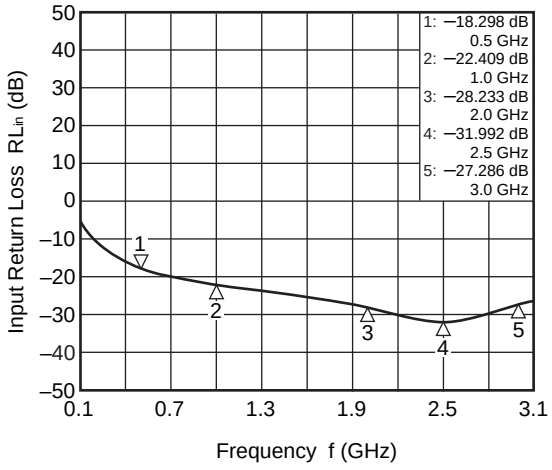
INPUT-OUTPUT1
ISOLATION vs. FREQUENCY



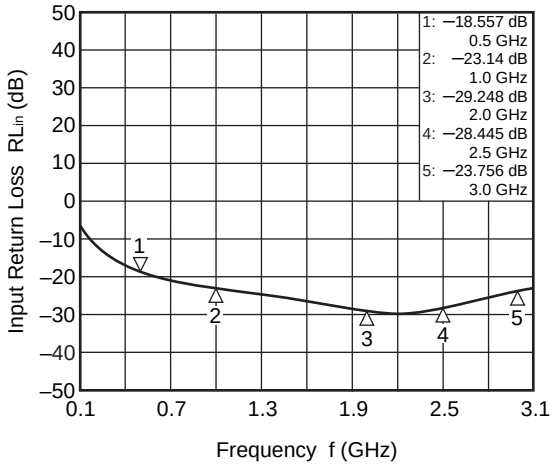
INPUT-OUTPUT2
ISOLATION vs. FREQUENCY



INPUT-OUTPUT1
INPUT RETURN LOSS vs. FREQUENCY

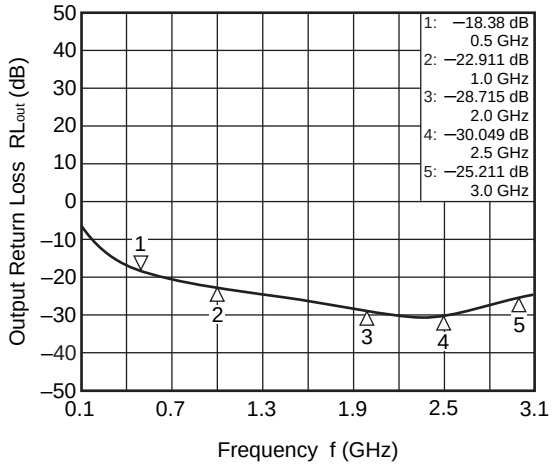


INPUT-OUTPUT2
INPUT RETURN LOSS vs. FREQUENCY

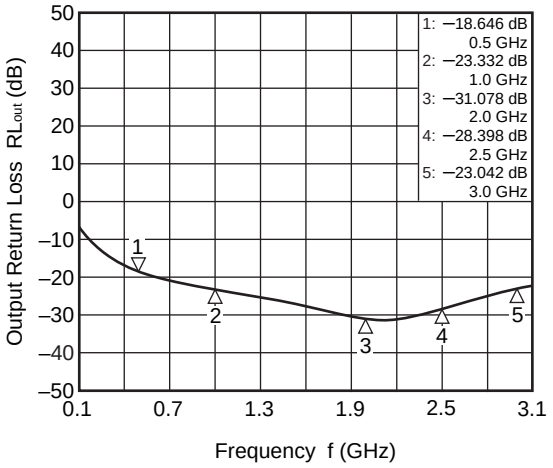


Remark The graphs indicate nominal characteristics.

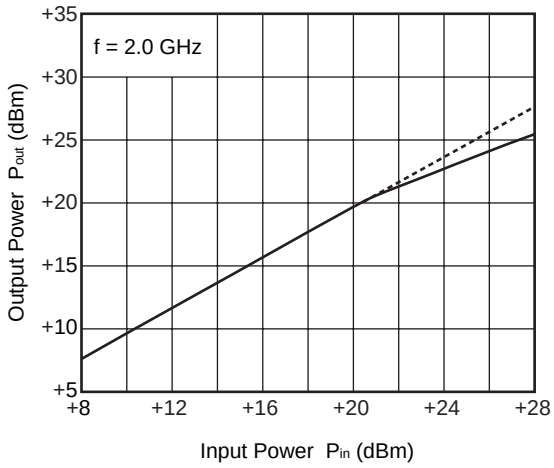
INPUT-OUTPUT1
OUTPUT RETURN LOSS vs. FREQUENCY



INPUT-OUTPUT2
OUTPUT RETURN LOSS vs. FREQUENCY



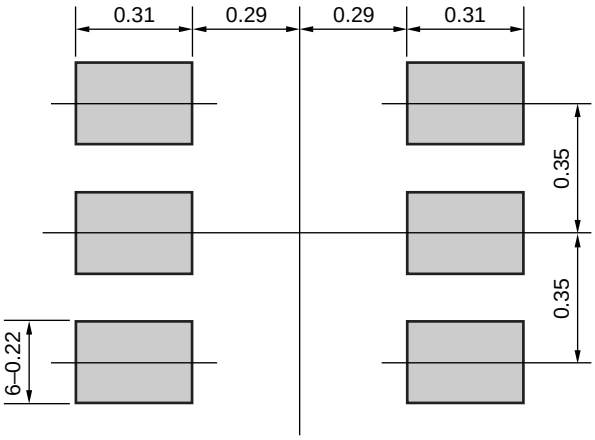
OUTPUT POWER vs. INPUT POWER



Remark The graphs indicate nominal characteristics.

MOUNTING PAD DIMENSIONS

6-PIN PLASTIC TSSON (UNIT: mm)

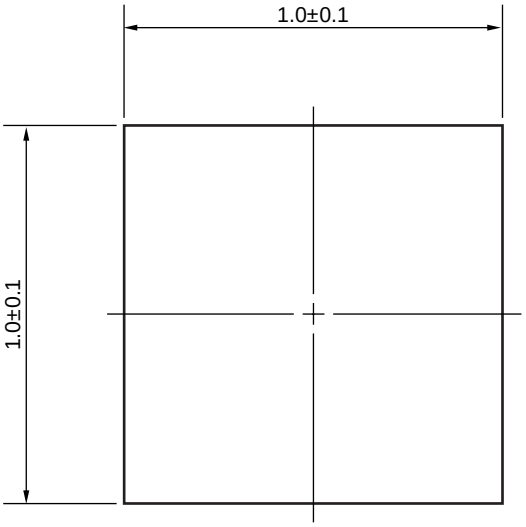


Remark The mounting pad layouts in this document are for reference only.

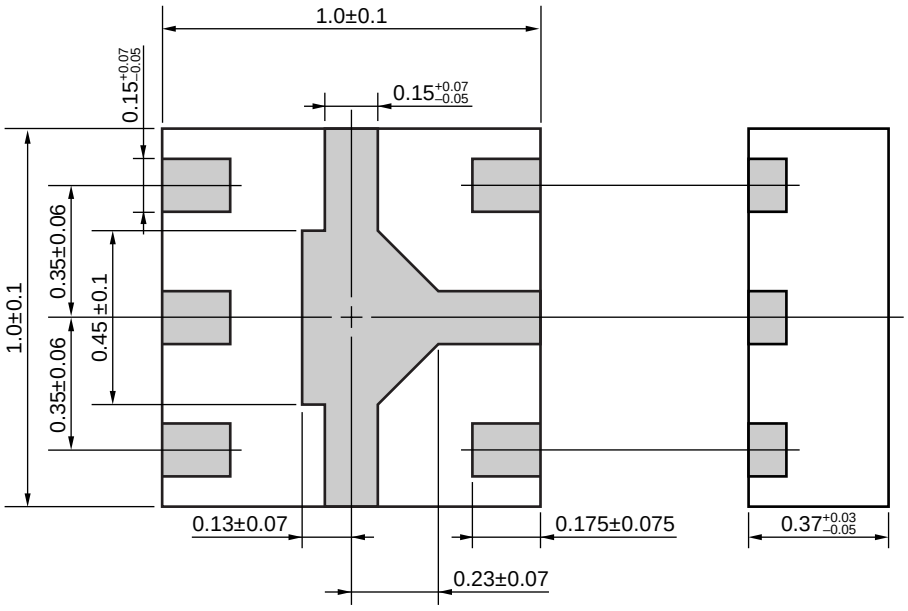
PACKAGE DIMENSIONS

6-PIN PLASTIC TSSON (UNIT: mm)

(Top View)



(Bottom View)



RECOMMENDED SOLDERING CONDITIONS

This product should be soldered and mounted under the following recommended conditions. For soldering methods and conditions other than those recommended below, contact your nearby sales office.

Soldering Method	Soldering Conditions		Condition Symbol
Infrared Reflow	Peak temperature (package surface temperature) Time at peak temperature Time at temperature of 220°C or higher Preheating time at 120 to 180°C Maximum number of reflow processes Maximum chlorine content of rosin flux (% mass)	: 260°C or below : 10 seconds or less : 60 seconds or less : 120±30 seconds : 3 times : 0.2%(Wt.) or below	IR260
Wave Soldering	Peak temperature (molten solder temperature) Time at peak temperature Preheating temperature (package surface temperature) Maximum number of flow processes Maximum chlorine content of rosin flux (% mass)	: 260°C or below : 10 seconds or less : 120°C or below : 1 time : 0.2%(Wt.) or below	WS260
Partial Heating	Peak temperature (terminal temperature) Soldering time (per side of device) Maximum chlorine content of rosin flux (% mass)	: 350°C or below : 3 seconds or less : 0.2%(Wt.) or below	HS350

Caution Do not use different soldering methods together (except for partial heating).

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Subject: Compliance with EU Directives

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This status is based on CEL's understanding of the EU Directives and knowledge of the materials that go into its products as of the date of disclosure of this information.

Restricted Substance per RoHS	Concentration Limit per RoHS (values are not yet fixed)	Concentration contained in CEL devices	
Lead (Pb)	< 1000 PPM	-A	-AZ
		Not Detected	(*)
Mercury	< 1000 PPM	Not Detected	
Cadmium	< 100 PPM	Not Detected	
Hexavalent Chromium	< 1000 PPM	Not Detected	
PBB	< 1000 PPM	Not Detected	
PBDE	< 1000 PPM	Not Detected	

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